

A

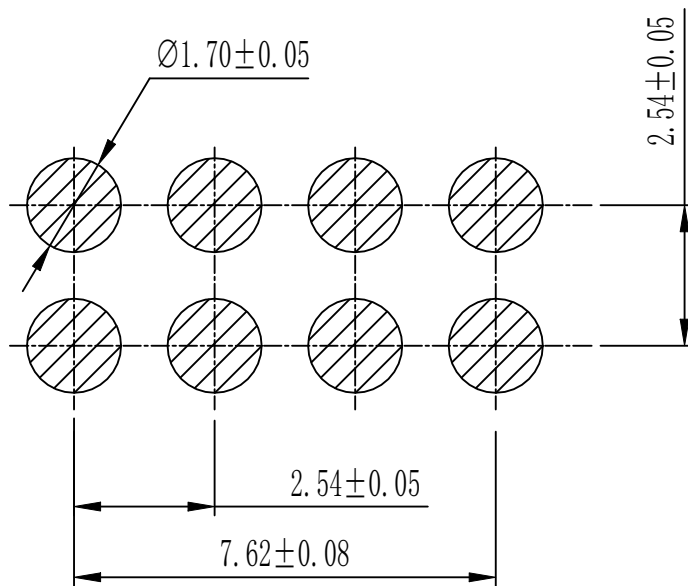
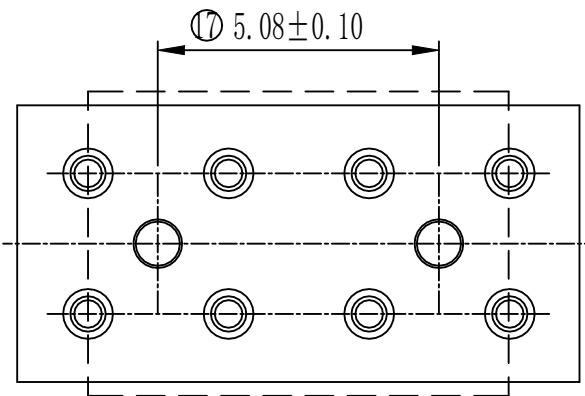
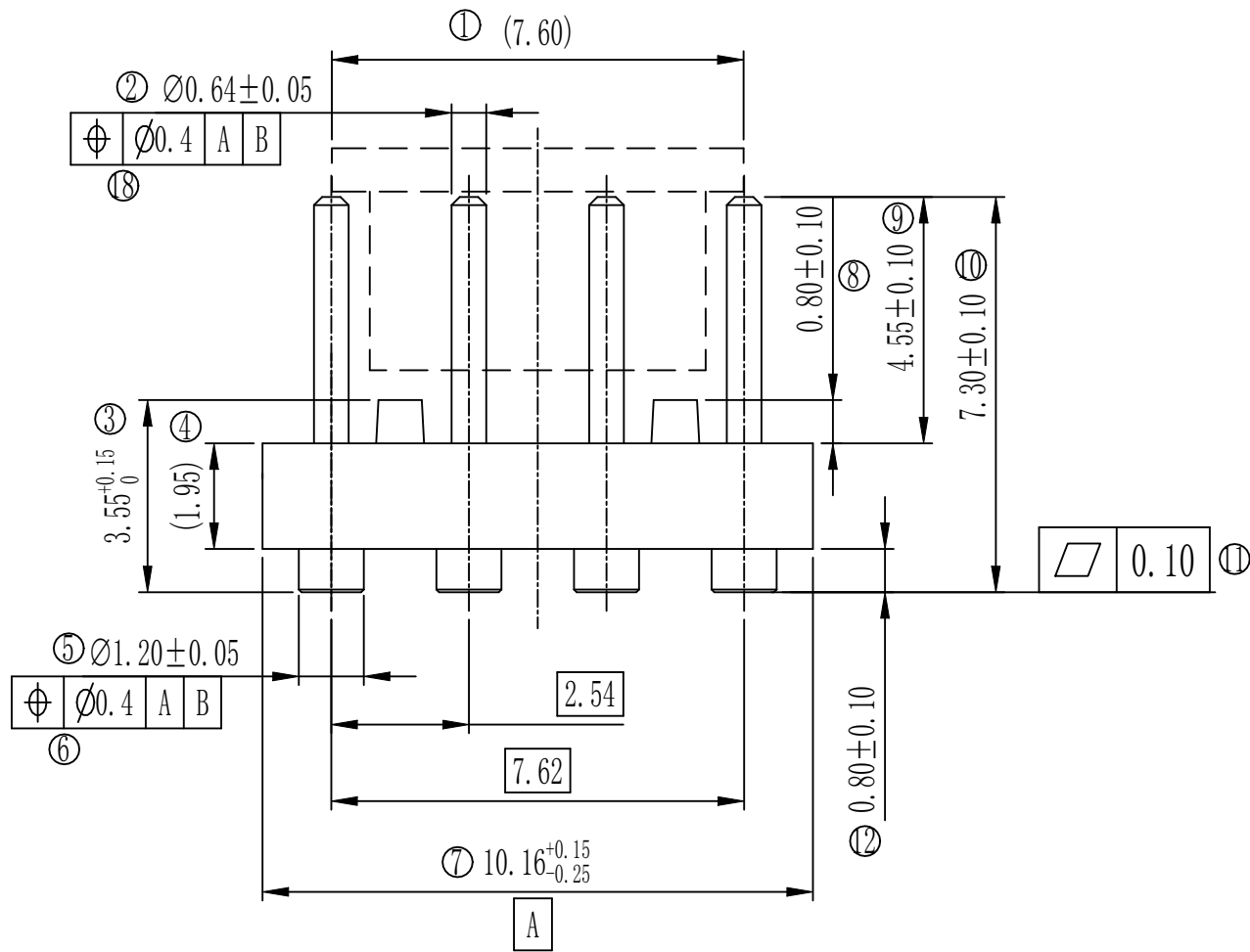
B

C

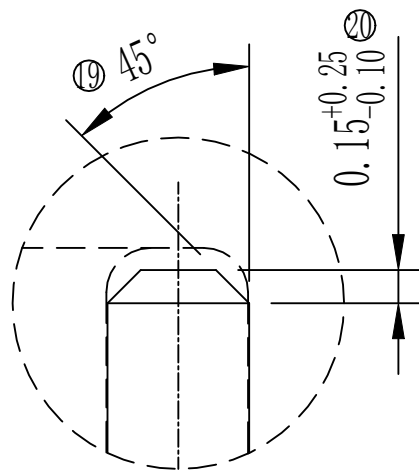
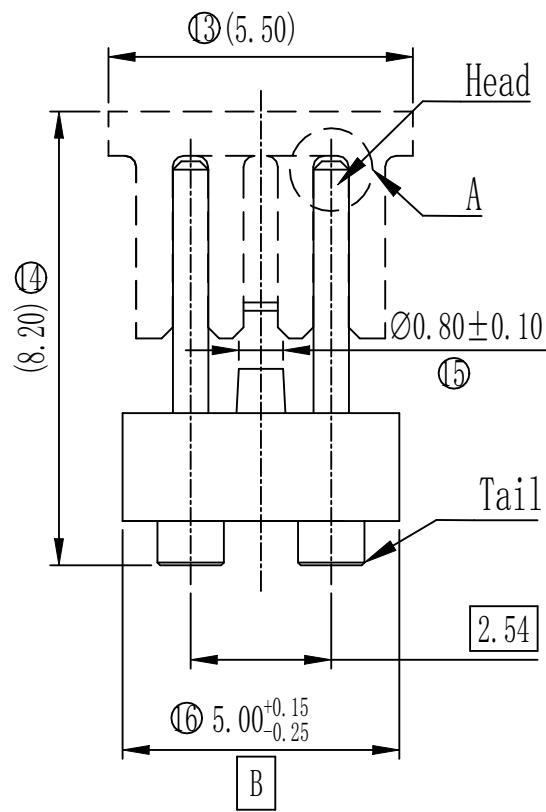
D

E

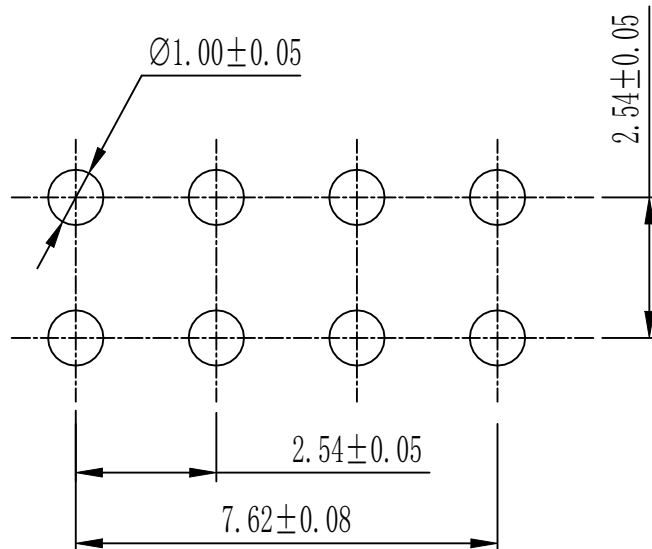
- Performance characteristics:
- 1.Main body part material
Insulator:LCP black,UL94V-0
Contact terminal: Phosphor bronze,1.27 μm Ni under plated, outer plated Au 0.025 μm min.
 - 2.Electrical requirements:
Current rating: 3 A
Contact resistance: ≤20 mΩ
Insulation resistance: ≥5000 MΩ
Withstanding voltage: 1000 Vr.m.s, 1mA, 60s
 - 3.Mechanical requirements
Retention: ≥4.5 N/pin
 - 4.Environment specification
Working temperature: -55℃~+125℃
Humidity: ≤93% at 40℃
Resistance to soldering heat: 260℃, 30s
 - 5.Packing & storing
Method of packing: Tape&reel, inner box
Storing condition: temperature of -10℃~+40℃
below 80% relative humidity
 - 6.Style of installation: SMT+PIP
 - 7.To prevent the pollution of the environment
product info :In line with the european union RoHS.



PCB LAYOUT(Tail)



Detail:A 4:1



PCB LAYOUT(Head)

Unless otherwise specified tolerance:

X.	±0.50	X. °	±3°
.X	±0.38	.X°	±2°
.XX	±0.25		

					2X4pin tail SMT connecting (Customer: HUAWEI)	SL0.1130.006			
Mark	NO.	File NO.	Signature	Date		Projection	Rev.	Weight	Scale
DRAW			Tang Jianping	2022.11.08			A0		
CHK					1130-087-29-3	All Dimensions in mm			
MAN						Sheet 1 of 1			
STD									
APP						SHINNING SHENZHEN SHINNING ELECTRONIC CO.,LTD.			